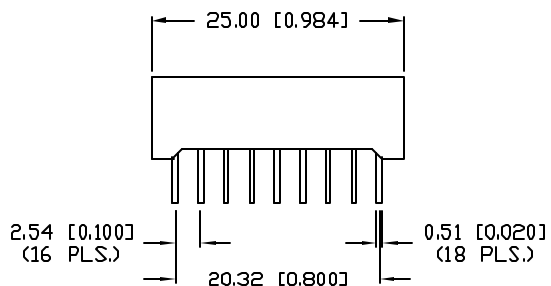
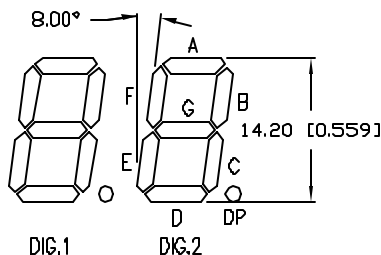


ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=10\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		660 (RED)		nm	
FORWARD VOLTAGE		1.8	2.3	V _f	
REVERSE VOLTAGE	4.0			V _r	I _r =100µA
AXIAL INTENSITY		13,300		µcd	I _f =10mA
EMITTED COLOR:	RED				
FACE COLOR:	GRAY				
SEGMENT COLOR:	MILKY WHITE DIFFUSED				



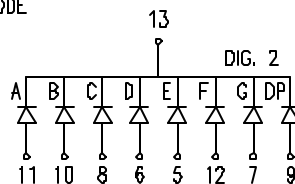
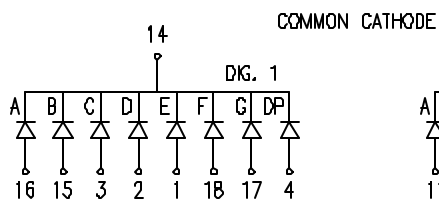
CHARACTER DETAIL



LIMITS OF SAFE OPERATION AT 25°C PER CHIP

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	100	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	°C
SOLDERING TEMP.	+260	°C
2.0mm FROM BODY	3 SEC. MAX	

* t<10µs



REPLACES PART#: LDD-C546RI

*UNLESS OTHERWISE SPECIFIED TOLERANCE IS ±0.25mm (±0.010")

REV.

PART NUMBER
LDD-C5646RI

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0.56" SEVEN SEGMENT, DUAL DIGIT DISPLAY, 660nm RED CHIPS WITH MILKY WHITE DIFFUSED SEGMENTS, GRAY FACE.

RELIABILITY NOTE
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY: | CHECKED BY: | APPROVED BY: | DATE: 8-27-98

PAGE: 1 OF 1

SCALE: N/A

BC